

2818



Attorney Docket No. 5649-958

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Lee et al.

Serial No.: 10/085,369

Filed: February 28, 2002

For: METHODS OF FABRICATING READ ONLY MEMORY DEVICES
INCLUDING THERMALLY OXIDIZED TRANSISTOR SIDEWALLS,
AND DEVICES SO FABRICATED

Group Art Unit: 2818

Examiner: Thao P. Le

Confirmation No.: 6590

April 29, 2003

Box NON-FEE AMENDMENT

Commissioner for Patents

Washington, DC 20231

AMENDMENT

Sir:

This Amendment is responsive to the Restriction Requirement of April 9, 2003

In the Title:

Please delete the title in all occurrences and substitute the following title
therefor: --METHODS OF FABRICATING READ ONLY MEMORY DEVICES
INCLUDING THERMALLY OXIDIZED TRANSISTOR SIDEWALLS--.

In the Claims:

Please cancel Claims 14-19 without prejudice to the filing of a divisional application.

REMARKS

In response to the Restriction Requirement of April 9, 2003, Applicants hereby elect Invention II, corresponding to Claims 1-13, drawn to a method of adhering copper thin film to a substrate. Applicants have canceled Invention I, corresponding to Claims 14-19, drawn to an integrated circuit having a copper interconnect. This cancellation is being made without prejudice to the filing of a divisional application for these claims.